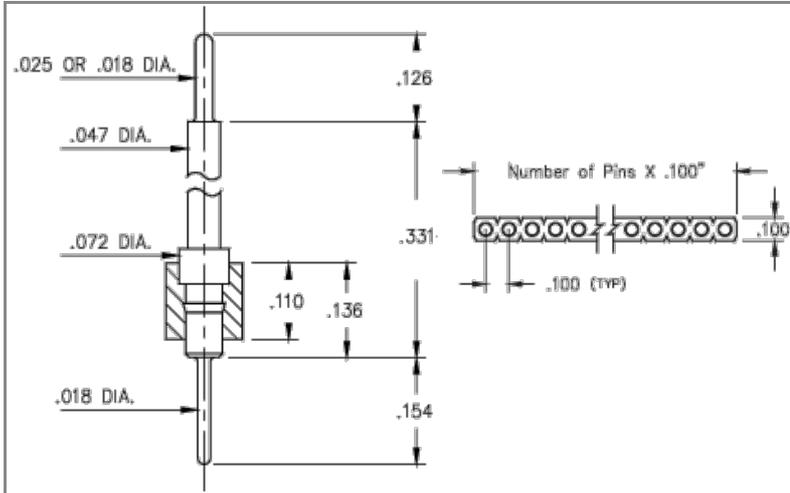


**PRODUCT NUMBER: 351-10-126-00-004000**



**DESCRIPTION**

Interconnect Machined Pin Header  
 Board Stacking Pin Header  
 .025" (0,635mm) Pin Head  
**Rows:** Single Row (1)  
**Pitch:** .100" (2,540mm)  
**Clip Grid:** 00  
**Pin Window Pattern** 004  
**Plating Code:** 10  
     **Shell:** 10 μ" Gold over 100 μ" Nickel  
**Insulator Pin Clip Type:** 000  
**Mounting Type:** Through Hole Solder Mount  
**Insulator Information:**  
 PCT High Temperature

<b># Pins</b>	<b>ROHS Compliant</b>
---------------	-----------------------

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**LOOSE PIN/RECEPTACLE USED:**

5504 (Brass Alloy)

**BRASS ALLOY 360 per ASTM B 16, or 385 per ASTM B455**

**Properties of BRASS ALLOY 360 ASTM B 16:**

- Chemical composition: Cu 63% (max), Pb 3.7% (max)†, Fe .35% (max), Zn remainder
- Temper as machined: H02/H04
- Yield Strength: 25-45 ksi
- Tensile strength: 57-80 ksi
- Hardness as machined: 80-90 Rockwell B
- Electrical conductivity: 26% IACS\*
- Melting point: 1000 °C/840 °C (liquidus/solidus)

**Properties of BRASS ALLOY 385 ASTM B 455:**

- Chemical composition: Cu 60% (max), Pb 3.5% (max)†, Fe .35% (max), Zn remainder
- Temper as machined: H02/H04
- Yield Strength: 16 ksi(min)
- Tensile strength: 48 ksi(min)
- Hardness as machined: 80-90 Rockwell B
- Electrical conductivity: 28% IACS\*
- Melting point: 1000 °C/840 °C (liquidus/solidus)

After machining, brass parts are often annealed (softened) for subsequent bending, swaging or crimping. A partial anneal down to 60±10 RB is recommended for 90° bends, a full anneal down to 35±15 RB is recommended for pins or terminals that

are swaged (riveted) to a circuitboard or crimped to a wire.

**Note:** Plated Brass parts need a barrier plate to prevent zinc diffusion, 50 $\mu$ " min. nickel or 100 $\mu$ " min. copper is recommended by ASTM B 545 and 579. ASTM B 488 also recommends a 50 $\mu$ " min. nickel barrier plate beneath gold to prevent copper diffusion inherent with all copper alloy products.

†RoHS-2 directive 2011/65/EU, exemption 6c allows up to 4% lead as an alloy agent in copper.

\*International Annealed Copper Standard, i.e. as a % of pure copper.

## INSULATOR MATERIAL:

### PCT Polyester (Injection Molded)

Properties:

- Polyester (30% glass filled), High Temp., (black). Flammability rating UL 94 V-0
- Rated voltage: 100 VRMS/150 VDC
- Insulation resistance: 10,000 Megaohms min.
- Material Heat Deflection Temp (per ASTM D 648): 529°F (276°C) @ 66 psi
- Dielectric strength: 1000 VRMS min. (700 VRMS min. for series 117 Shrink DIP)

Note: Materials with HDT above 446°F (230°C) are considered suitable for "eutectic" reflow soldering. For "lead-free" reflow soldering, choose materials with an HDT above 500°F (260°C). PCT is the standard plastic used with RoHS "lead-free" plated pins.

## ADDITIONAL NOTES & SPECIFICATIONS

In the interest of improved design, quality and performance, Mill-Max reserves the right to make changes in its specifications without prior notice. Specifications and tolerances are provided wherever possible. Due to the wide variety of interconnects Mill-Max offers, the specific tolerances vary from product to product. If you need information regarding the tolerance of a particular part, please contact Technical Services.

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